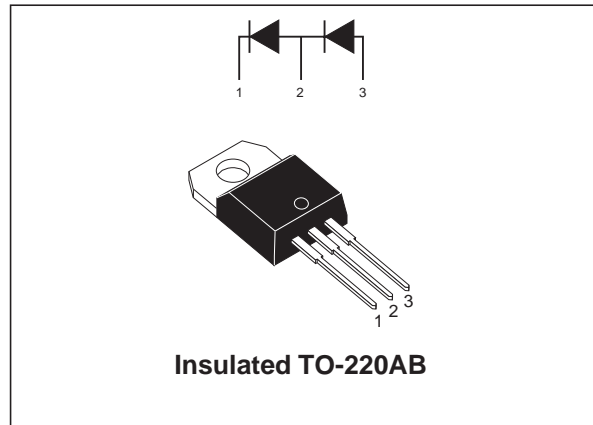


TURBOSWITCH™ Tandem 600V ULTRA-FAST BOOST DIODE
MAJOR PRODUCTS CHARACTERISTICS

I_{F(AV)}	8 A
V_{RRM}	600 V (in series)
T_{j (max)}	150 °C
V_{F (max)}	2.6 V
I_{RM (typ.)}	4 A

FEATURES AND BENEFITS

- ESPECIALLY SUITED AS BOOST DIODE IN CONTINUOUS MODE POWER FACTOR CORRECTORS AND HARD SWITCHING CONDITIONS.
- DESIGNED FOR HIGH DI/DT OPERATION.
- ULTRA-FAST RECOVERY CURRENT TO COMPETE WITH GaAs DEVICES. SIZE DIMINUTION OF MOSFET AND HEATSINKS ALLOWED.
- INTERNAL CERAMIC INSULATED PACKAGE ALLOWS FLEXIBLE HEATSINKING ON COMMON OR SEPARATE HEATSINK.
- MATCHED DIODES FOR TYPICAL PFC APPLICATION WITHOUT VOLTAGE BALANCE NETWORK.
- INSULATED VERSION: :
Insulated voltage = 2500 V_(RMS)
Capacitance = 7 pF


DESCRIPTION

The TURBOSWITCH "H" is an ultra high performance diode composed of two 300V dice in series. TURBOSWITCH "H" family drastically cuts losses in the associated MOSFET when run at high di_F/dt.

ABSOLUTE RATINGS (limiting values for both diodes in series)

Symbol	Parameter		Value	Unit
V _{RRM}	Repetitive peak reverse voltage		600	V
I _{F(RMS)}	RMS forward current		14	A
I _{FSM}	Surge non repetitive forward current	tp = 10 ms sinusoidal	80	A
T _{stg}	Storage temperature range		-65 +150	°C
T _j	Maximum operating junction temperature		+ 150	°C

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STTH806TTI

THERMAL AND POWER DATA

Symbol	Parameter	Test conditions	Value	Unit
$R_{th(j-c)}$	Junction to case thermal resistance	Per diode	5	°C/W
$R_{th(c)}$		Coupling	0.2	
$R_{th(j-c)}$	Junction to case thermal resistance	Total	2.6	
P_1	Conduction power dissipation for both diodes	$I_{F(AV)} = 8\text{ A}$ $\delta = 0.5$ $T_c = 80^\circ\text{C}$	27	W

STATIC ELECTRICAL CHARACTERISTICS (for both diodes)

Symbol	Parameter	Tests Conditions	Min.	Typ.	Max.	Unit
I_R^*	Reverse leakage current	$V_R = V_{RRM}$	$T_j = 25^\circ\text{C}$		10	μA
			$T_j = 125^\circ\text{C}$		15	
V_F^{**}	Forward voltage drop	$I_F = 8\text{ A}$	$T_j = 25^\circ\text{C}$		3.6	V
			$T_j = 125^\circ\text{C}$		2.1	

Pulse test : * $t_p = 5\text{ ms}$, $\delta < 2\%$

** $t_p = 380\text{ }\mu\text{s}$, $\delta < 2\%$

To evaluate the maximum conduction losses use the following equation :

$$P = 1.8 \times I_{F(AV)} + 0.1 I_{F(RMS)}^2$$

RECOVERY CHARACTERISTICS

Symbol	Tests Conditions	Min.	Typ.	Max.	Unit
t_{rr}	$I_F = 0.5\text{ A}$ $I_{rr} = 0.25\text{ A}$ $I_R = 1\text{ A}$		13	30	ns
	$I_F = 1\text{ A}$ $di_F/dt = -50\text{ A}/\mu\text{s}$ $V_R = 30\text{ V}$				
I_{RM}	$V_R = 400\text{ V}$ $I_F = 8\text{ A}$ $di_F/dt = -200\text{ A}/\mu\text{s}$		4	5.5	A
S_{factor}			0.4		-

TURN-ON SWITCHING CHARACTERISTICS

Symbol	Tests Conditions	Min.	Typ.	Max.	Unit
t_{fr}	$I_F = 8\text{ A}$ $di_F/dt = 100\text{ A}/\mu\text{s}$, measured at $1.1 \times V_F\text{ max}$			200	ns
V_{FP}	$I_F = 8\text{ A}$ $di_F/dt = 100\text{ A}/\mu\text{s}$			7	V

Fig. 1: Conduction losses versus average current.

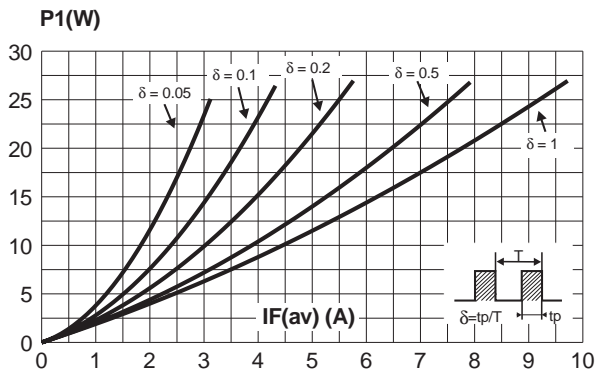


Fig. 2: Forward voltage drop versus forward current.

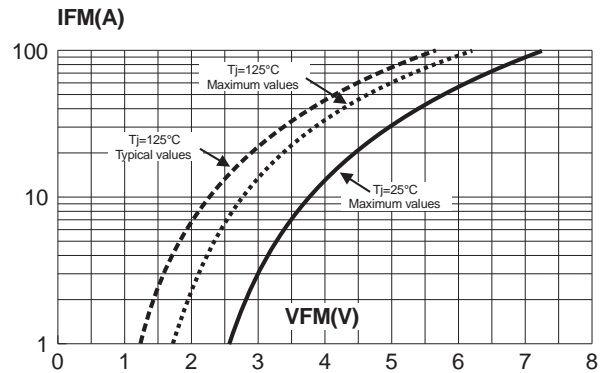


Fig. 3: Relative variation of thermal impedance junction to case versus pulse duration.

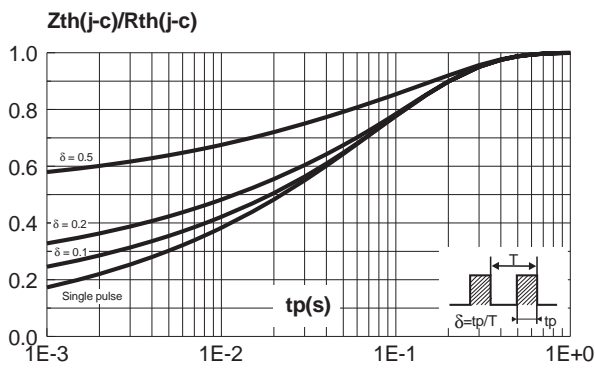


Fig. 4: Peak reverse recovery current versus dIF/dt (90% confidence).

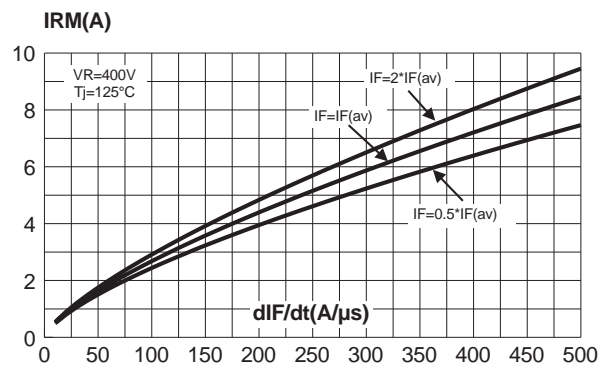


Fig. 5: Reverse recovery time versus dIF/dt (90% confidence).

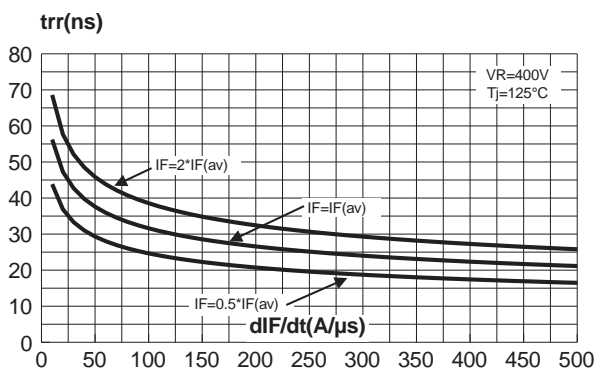


Fig. 6: Reverse charges versus dIF/dt (90% confidence).

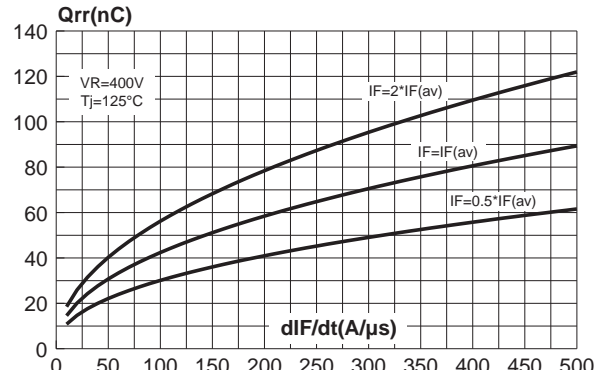


Fig. 7: Softness factor versus di_F/dt (typical values).

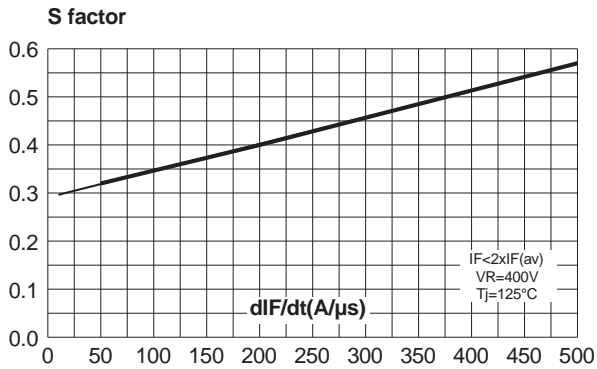


Fig. 8: Relative variation of dynamic parameters versus junction temperature (reference: $T_j = 125^\circ\text{C}$).

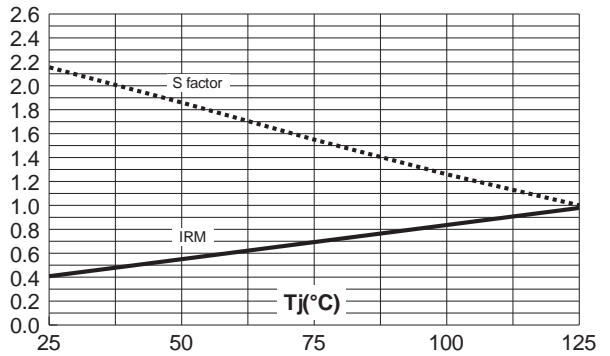


Fig. 9: Transient peak forward voltage versus di_F/dt (90% confidence).

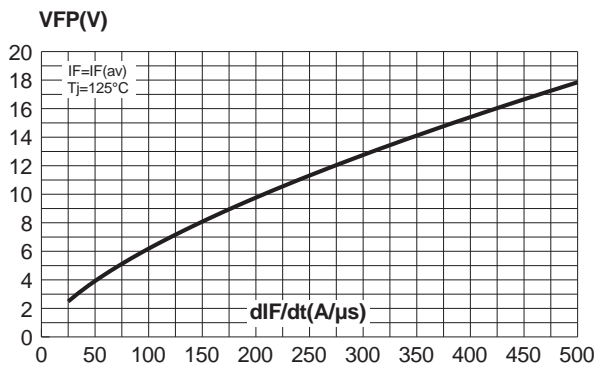
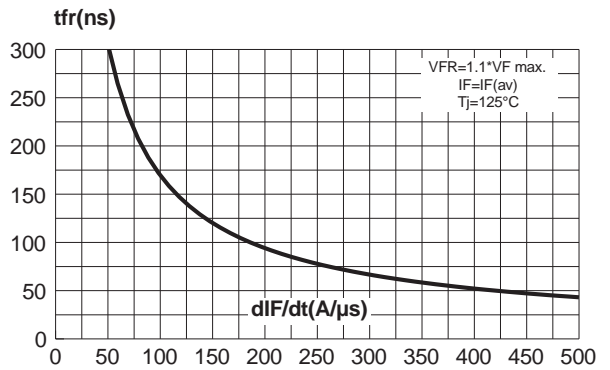
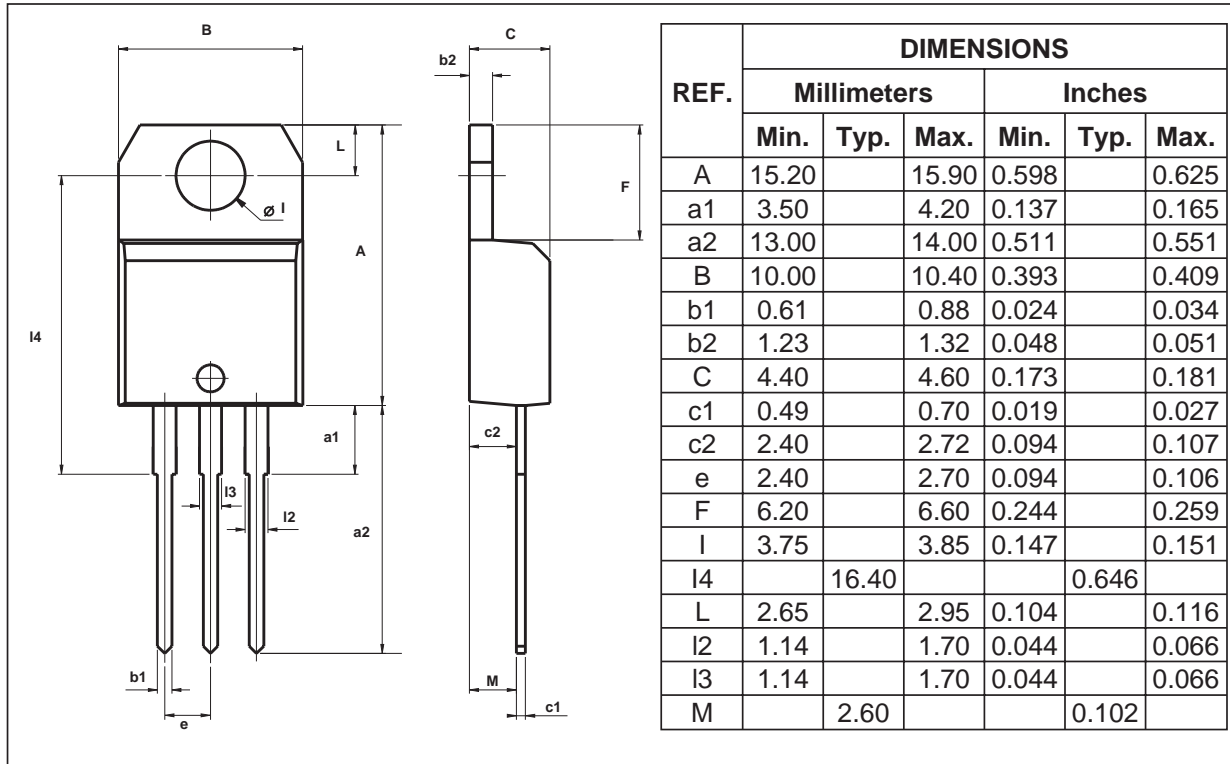


Fig. 10: Forward recovery time versus di_F/dt (90% confidence).



PACKAGE MECHANICAL DATA
 TO-220AB


Ordering code	Marking	Package	Weight	Base qty	Delivery mode
STTH806TTI	STTH806TTI	TO-220AB	2.3 g.	50	Tube

- Cooling method: C
- Recommended torque value: 0.8 N.m.
- Maximum torque value: 1 N.m.
- Epoxy meets UL94,V0

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